

# NB3N3010B

## 3.3V, 12.288 MHz Audio Oversampling Clock Generator for USB Applications



ON Semiconductor®

<http://onsemi.com>

### Description

The NB3N3010B is a precision, low noise clock multiplier that generates an output frequency of 12.288 MHz. This is accomplished by using Frequency-Locked-Loop (FLL) techniques where a 4 kHz reference input is multiplied by 3072, or an 8 kHz input by 1536. The frequency multiplier is selected by the S0 pin.

The two LVCMOS output drivers are disabled to a logic Low with the ENABLEn pin set HIGH. The NB3N3010B operates from a single +3.3 V supply, and is available in the SOIC-8 pin package, and optionally in a DFN8 package. The operating temperature range is from 0°C to +85°C.

The NB3N3010B device provides the optimum combination of low cost, flexibility, and high performance. This makes it ideal for applications such as oversampling A-to-D and D-to-A converters from a low reference frequency, such as a USB start-of-frame (SOF) pulse.

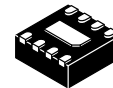
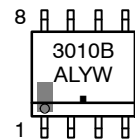
### Features

- Accepts 8 kHz or 4 kHz Reference Input Derived from USB Start-of-Frame
- Generates 12.288 MHz Frequency-Locked to the Reference
- Fully Integrated Frequency-Lock-Loop with Internal Loop Filter
- Low Skew Dual LVCMOS Outputs
- Very Low Phase Noise Preserves Codec Noise Floor
- Internal Voltage Regulator
- Supply Voltage Required: +3.3 V ± 5%
- Temperature Range: 0°C to +85°C
- These are Pb-Free Devices

### MARKING DIAGRAMS\*



SOIC-8  
D SUFFIX  
CASE 751



DFN8  
MN SUFFIX  
CASE 506AA



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

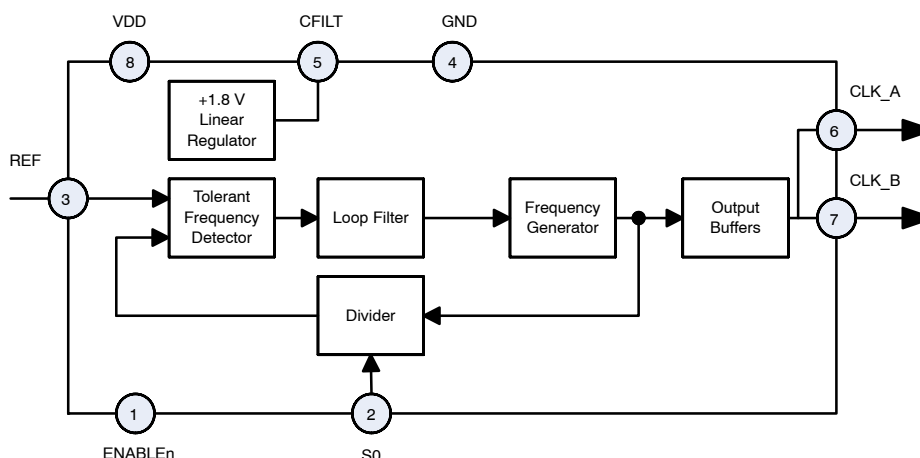
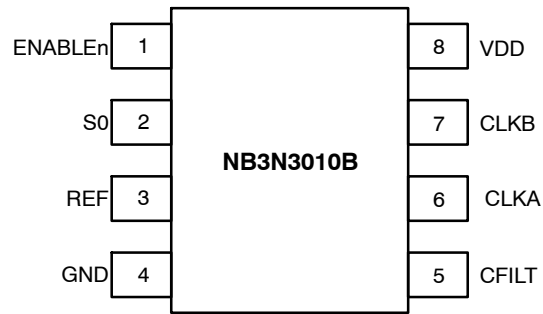


Figure 1. NB3N3010B Simplified Diagram

## NB3N3010B



**Figure 2. Pinout SOIC-8 / DFN8 (Top View)**

**Table 1. PIN DESCRIPTION**

| Pin | Symbol  | I/O                    | Description  |
|-----|---------|------------------------|--|
| 1   | ENABLEn | LVTTL/<br>LVCMOS Input | Low active Output Enable; Defaults HIGH when left open; Internal pull-up resistor to V <sub>DD</sub> .   |
| 2   | S0      | LVTTL/<br>LVCMOS Input | Frequency Select Input. See input frequency select Table 2 for details. Defaults HIGH when left open. Internal pull-up resistor to V <sub>DD</sub> . |
| 3   | REF     | Input                  | Reference Clock input  |
| 4   | GND     | Power Supply           | Negative Supply Voltage; Ground 0 V. This pin provides GND return path to the VDD supply.  |
| 5   | CFILT   | Analog                 | Connection for external filter capacitor for internal +1.8 V regulator; see Figure 4.  |
| 6   | CLKA    | LVCMOS<br>Output       | Clock output, copy A (12.288 MHz)  |
| 7   | CLKB    | LVCMOS<br>Output       | Clock output, copy B (12.288 MHz)  |
| 8   | VDD     | Power Supply           | Positive Supply Voltage, +3.3 V ± 5%   |

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**Table 2. ATTRIBUTES**

| Characteristic  |                                   | Value                |
|---|-----------------------------------|----------------------|
| ESD Protection  | Human Body Model<br>Machine Model | > 4 kV<br>400 V      |
| R <sub>PU</sub> – ENABLEn Input Pull-up Resistor<br>R <sub>PU</sub> – SO Input Pull-up Resistor |                                   | 48 kΩ<br>48 kΩ       |
| Moisture Sensitivity (Note 1)   | Pb-Free                           | Level 1              |
| Flammability Rating   | Oxygen Index: 28 to 34            | UL 94 V-0 @ 0.125 in |
| Transistor Count  |                                   | 12039                |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test  |                                   |                      |

1. For additional information, see Application Note AND8003/D.

**Table 3. ABSOLUTE MAXIMUM RATINGS**

| Symbol           | Parameter                                | Condition 1        | Condition 2                | Rating                            | Unit         |
|------------------|--|--------------------|----------------------------|-----------------------------------|--------------|
| V <sub>DD</sub>  | Positive Power Supply                    | GND = 0 V          |                            | 4.6                               | V            |
| V <sub>I</sub>   | Input Voltage (VIN)                      | GND = 0 V          |                            | -0.3 V to V <sub>DD</sub> + 0.3 V | V            |
| T <sub>A</sub>   | Operating Temperature Range              |                    |                            | 0 to +85                          | °C           |
| T <sub>stg</sub> | Storage Temperature Range                |                    |                            | -40 to +150                       | °C           |
| θ <sub>JA</sub>  | Thermal Resistance (Junction-to-Ambient) | 0 lfpm<br>500 lfpm | SOIC-8<br>SOIC-8           | 190<br>130                        | °C/W<br>°C/W |
| θ <sub>JC</sub>  | Thermal Resistance (Junction-to-Case)    | (Note 2)           | SOIC-8                     | 41 to 44                          | °C/W         |
| θ <sub>JA</sub>  | Thermal Resistance (Junction-to-Ambient) | 0 lfpm<br>500 lfpm | DFN-8 (2x2)<br>DFN-8 (2x2) | 129<br>84                         | °C/W         |
| θ <sub>JC</sub>  | Thermal Resistance (Junction-to-Case)    | (Note 2)           | DFN-8 (2x2)                | 35-40                             | °C/W         |
| T <sub>sol</sub> | Wave Solder                              | Pb-Free            |                            | 265                               | °C           |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power).

**Table 4. DC CHARACTERISTICS** V<sub>DD</sub> = 3.3 V ± 5%, GND = 0 V, T<sub>A</sub> = 0°C to +85°C, Note 3.

| Symbol             | Characteristic   | Min       | Typ | Max                   | Unit |
|--------------------|--|-----------|-----|-----------------------|------|
| V <sub>DD</sub>    | Power Supply Voltage   | 3.13      | 3.3 | 3.47                  | V    |
| I <sub>DDOEL</sub> | Power Supply Current (operating, i.e. ENABLEn is LOW) Outputs Unloaded |           | 21  | 35                    | mA   |
| I <sub>DDOEH</sub> | Power Supply Current (standby, i.e. ENABLEn is HIGH)                   |           | 415 | 600                   | µA   |
| V <sub>IH</sub>    | Input HIGH Voltage (REF, ENABLEn, S0)                                  | 2.0       |     | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub>    | Input LOW Voltage (REF, ENABLEn, S0)                                   | GND – 0.3 |     | 0.8                   | V    |
| V <sub>OH</sub>    | Output HIGH Voltage (CLKA, CLKB), I <sub>OH</sub> = -12 mA             | 2.4       |     |                       | V    |
| V <sub>OL</sub>    | Output LOW Voltage (CLKA, CLKB), I <sub>OL</sub> = 12 mA               |           |     | 0.4                   | V    |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. C<sub>FILT</sub> capacitor must be installed; see Figure 4.

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**Table 5. AC CHARACTERISTICS**  $V_{DD} = 3.3\text{ V} \pm 5\%$ ,  $GND = 0\text{ V}$ ,  $T_A = 0^\circ\text{C}$  to  $+85^\circ\text{C}$  (Note 4)

| Symbol             | Characteristic  | Min          | Typ      | Max    | Unit     |     |
|--------------------|---|--------------|----------|--------|----------|-----|
| $f_{out}$          | Output Clock Frequency: CLKA & CLKB<br>$f_{OUT} = 8\text{ kHz} \times 1536$<br>$f_{OUT} = 4\text{ kHz} \times 3072$ | $S0 = 1$     | 12.25728 | 12.288 | 12.31872 | MHz |
|                    |   | $S0 = 0$     | 12.25728 | 12.288 | 12.31872 |     |
| $f_{REF}$          | Reference Input Frequency   | $S0 = 1$     | 7.98     | 8      | 8.02     | kHz |
|                    |   | $S0 = 0$     | 3.99     | 4      | 4.01     |     |
| $t_{jit(per)-ref}$ | Reference Input Period Jitter (pk-pk)   |              |          | 250    | ns       |     |
| $t_{REFH}$         | Reference Input Pulse Width (high)  | $S0 = 1$     | 33       |        | 68000    | ns  |
|                    |   | $S0 = 0$     | 33       |        | 136000   |     |
| $t_{CLKH}$         | CLKA, CLKB output width, high   | 13           |          |        | ns       |     |
| $t_{CLKL}$         | CLKA, CLKB output width, low  | 13           |          |        | ns       |     |
| $t_r$              | CLKA, CLKB rise time 10% – 90%  |              |          | 4      | ns       |     |
| $t_f$              | CLKA, CLKB fall time 90% – 10%  |              |          | 4      | ns       |     |
| $t_{jit(per)}$     | CLKA, CLKB period jitter (over 10k cycles)  | peak-to-peak |          |        | 250      | ps  |
|                    |   | RMS          |          |        | 20       |     |
| $t_{jit(cc)}$      | CLK_A, CLKB cycle-to-cycle jitter (1k cycles)   | peak-to-peak |          |        | 300      | ps  |
|                    |   | RMS          |          |        | 35       |     |
| $t_{sk(LH)}$       | CLKA to CLKB output skew (low-to-high transitions)  |              |          | 700    | ps       |     |
| $t_{sk(HL)}$       | CLKA to CLKB output skew (high-to-low transitions)  |              |          | 700    | ps       |     |
|                    | Power Valid to ENABLEn  |              |          | 10     | ms       |     |
|                    | ENABLEn to CLKA/CLKB  |              | 50       | 100    | ms       |     |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Outputs loaded with 15 pF max to ground.  $C_{FILT}$  capacitor must be installed; see Figure 4.
- Maximum time required after power is applied to the MCLK FLL until it is ready to accept ENABLEn active.

# NB3N3010B

## APPLICATION INFORMATION

Figure 1 shows the simplified block diagram of the NB3N3010B device.

The primary function of the NB3N3010B is to accept a selectable 4 kHz or 8 kHz input reference clock, REF, and then multiply it to 12.288 MHz output frequency.

### Frequency Select – S0

Either of two expected input REF frequencies, 4 kHz or 8 kHz, will be multiplied by the FLL to achieve 12.288 MHz at the low-skew CLKA and CLKB outputs by selecting the S0 pin; see Table 6.

The pulse high time ( $T_{HI}$ ) of the input reference signal may vary widely depending on the application. See AC specifications for details.

### Output Enable – ENABLEn

A Low active output enable input pin, ENABLEn, is provided. When the ENABLEn input is High inactive, both clock outputs are driven to a logic Low.

The NB3N3010B implements a delay, specified as ENABLEn to Output Delay in the AC Specifications, from the assertion of ENABLEn to the first rising edges on the clock outputs. This delay insures that CLKA and CLKB output pulses are within specification before the output drivers are enabled. When ENABLEn transitions from Low to High (de-asserts), the current cycle of the clock outputs completes normally then the outputs will be held Low. The ENABLEn signal is asynchronous to either the REF input or CLK\_x outputs.

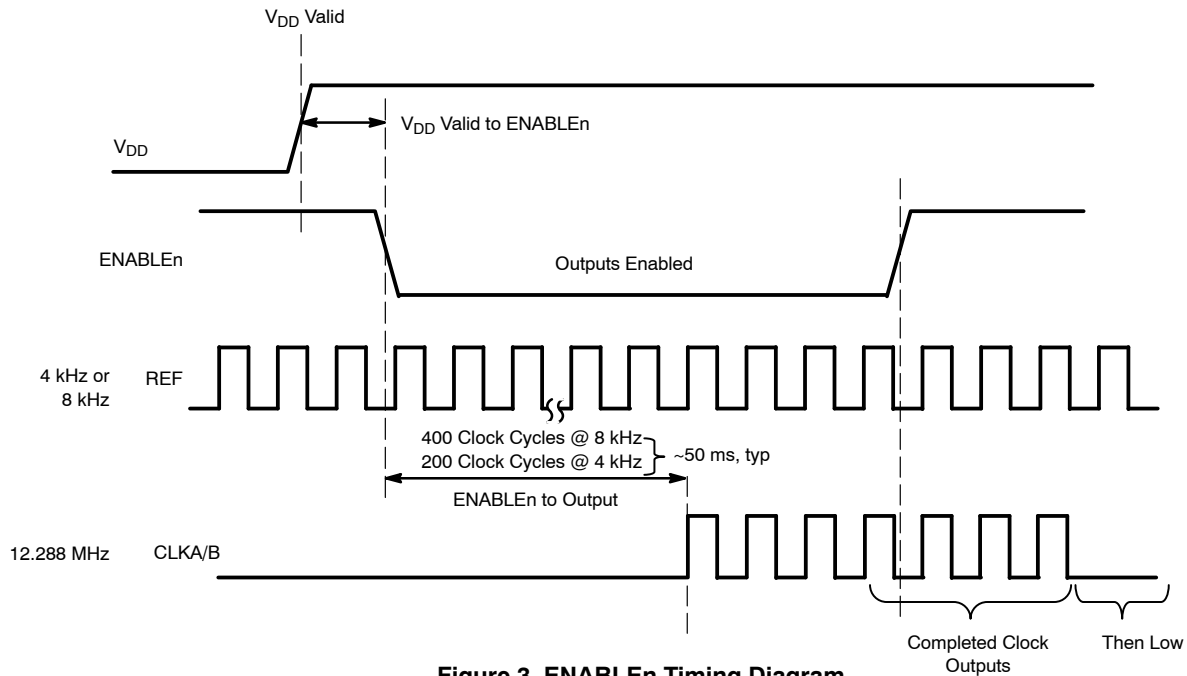
**Table 6. INPUT FREQUENCY SELECT AND OUTPUT ENABLE FUNCTIONS**

| ENABLEn* | S0* | f <sub>REF</sub> | FLL Multiplier | CLKA & CLKB Frequency |
|----------|-----|------------------|----------------|-----------------------|
| 0        | L   | 4 kHz            | 3072           | 12.288 MHz            |
| 0        | H   | 8 kHz            | 1536           | 12.288 MHz            |
| 1        | x   | x                | x              | Disabled Low          |

\*Defaults High when left open.

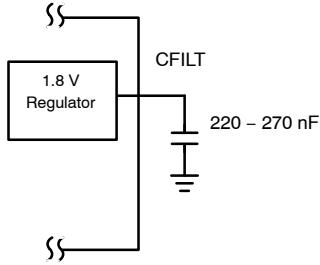
### Typical Power On Sequence

1. Power On
2. Reference Clock present; must be switching before ENABLEn goes High.
3. Output Enable, ENABLEn, High-to-Low



**Figure 3. ENABLEn Timing Diagram**

**CFILT for 1.8 V Regulator**

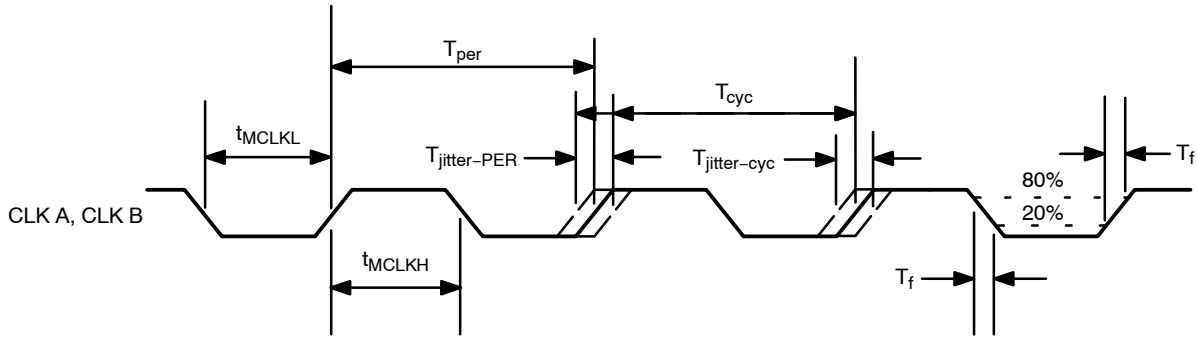


**Figure 4. CFILT Capacitor**

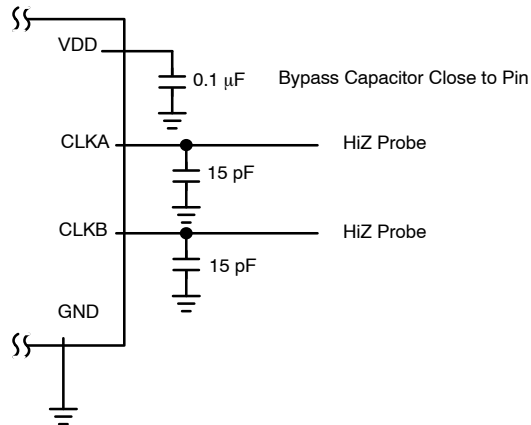
A low noise 1.8 V LDO/Regulator is integrated to provide a clean supply for the CLKA/CLKB output buffers. The LDO requires a decoupling capacitor in the range of 220 nF to 270 nF for compensation and high frequency PSR, and should be located near the device. The purpose of this design technique is to isolate the high switching noise of the digital outputs from the relatively sensitive internal analog phase-locked loop.



**Figure 5. REF Input Timing Diagram**



**Figure 6. Clock Output Timing Diagram**



**Figure 7. Test Circuit**

# NB3N3010B

## ORDERING INFORMATION

| Device          | Package             | Shipping <sup>†</sup> |
|-----------------|---------------------|-----------------------|
| NB3N3010BDG     | SOIC-8<br>(Pb-Free) | 98 Units / Rail       |
| NB3N3010BDR2G   | SOIC-8<br>(Pb-Free) | 2500 / Tape & Reel    |
| NB3N3010BMNG*   | DFN-8<br>(Pb-Free)  | TBD Units / Rail      |
| NB3N3010BMNR4G* | DFN-8<br>(Pb-Free)  | 1000 / Tape & Reel    |

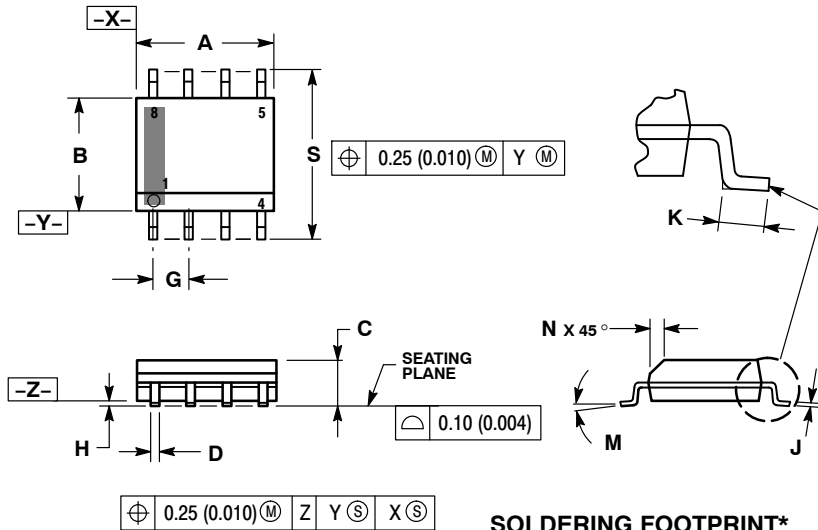
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*To order other package and voltage variants, please contact your ON Semiconductor sales representative.

# NB3N3010B

## PACKAGE DIMENSIONS

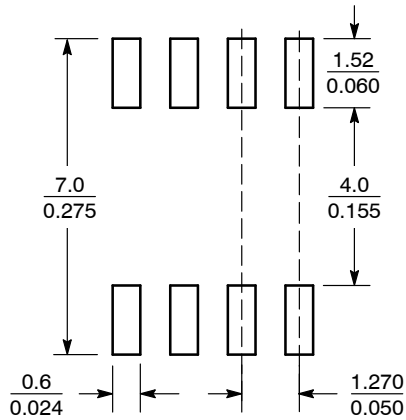
SOIC-8 NB  
CASE 751-07  
ISSUE AK



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.80        | 5.00 | 0.189     | 0.197 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.053     | 0.069 |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 0.10        | 0.25 | 0.004     | 0.010 |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |
| K   | 0.40        | 1.27 | 0.016     | 0.050 |
| M   | 0°          | 8°   | 0°        | 8°    |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |

### SOLDERING FOOTPRINT\*



SCALE 6:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

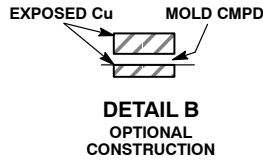
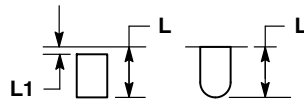
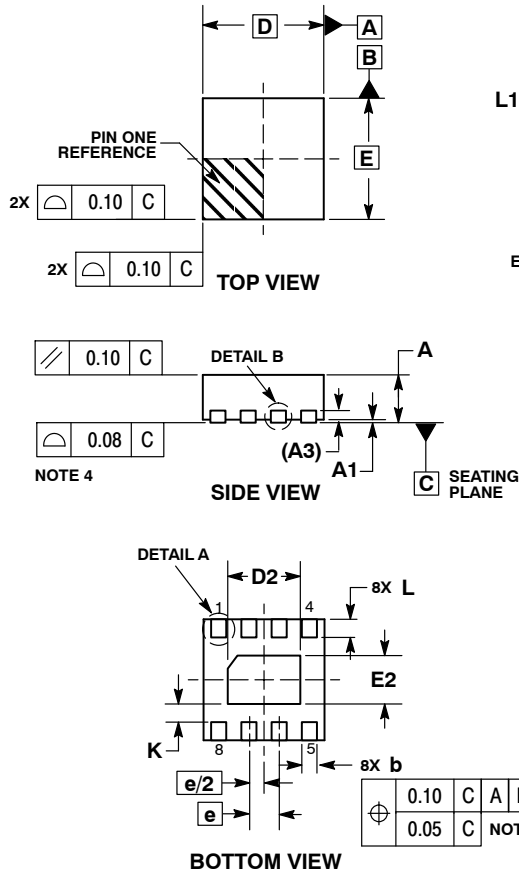
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# NB3N3010B

## PACKAGE DIMENSIONS

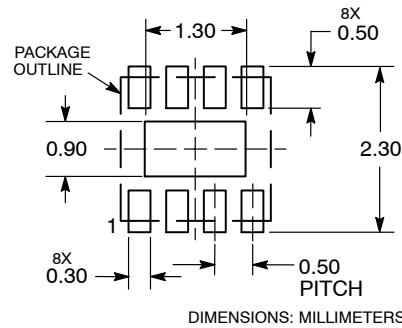
DFN8 2x2, 0.5P  
CASE 506AA-01  
ISSUE E



- NOTES:
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  - CONTROLLING DIMENSION: MILLIMETERS.
  - DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
  - COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.80        | 1.00 |
| A1  | 0.00        | 0.05 |
| A3  | 0.20        | REF  |
| b   | 0.20        | 0.30 |
| D   | 2.00        | BSC  |
| D2  | 1.10        | 1.30 |
| E   | 2.00        | BSC  |
| E2  | 0.70        | 0.90 |
| e   | 0.50        | BSC  |
| K   | 0.30        | REF  |
| L   | 0.25        | 0.35 |
| L1  | ---         | 0.10 |

### RECOMMENDED SOLDERING FOOTPRINT\*



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